

MOSFET – Power, Dual, N-Channel, for 1-2 Cells Lithium-ion Battery Protection

20 V, 30 mΩ, 6 A

EFC3C001NUZ

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1–2 cells lithium–ion battery applications.

Features

- 2.5 V Drive
- Common-Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halide Free and RoHS Compliant

Applications

• 1-2 Cells Lithium-ion Battery Charging and Discharging Switch

Specifications

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter	Symbol	Value	Unit
Source to Source Voltage	V _{SSS}	20	V
Gate to Source Voltage	V _{GSS}	±10	V
Source Current (DC)	I _S	6	Α
Source Current (Pulse) PW ≤ 100 μs, duty cycle ≤ 1%	I _{SP}	60	Α
Total Dissipation (Note 1)	PT	1.6	W
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

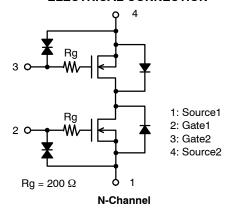
THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\theta JA}$	78.1	°C/W

^{1.} Surface mounted on ceramic substrate (5000 $\text{mm}^2 \times 0.8 \text{ mm}$).

V _{SSS}	R _{SS(on)} Max	I _S Max
20 V	30 mΩ @ 4.5 V	6 A
	34 mΩ @ 3.8 V	
	39 mΩ @ 3.1 V	
	56 mΩ @ 2.5 V	

ELECTRICAL CONNECTION





WLCSP4 1.26x1.26 / EFCP1313-4DG-020 CASE 567LM

MARKING DIAGRAM

WC YMZZ

WC = Specific Device Code

= Year

M = Month

ZZ = Assembly Lot Number

ORDERING INFORMATION

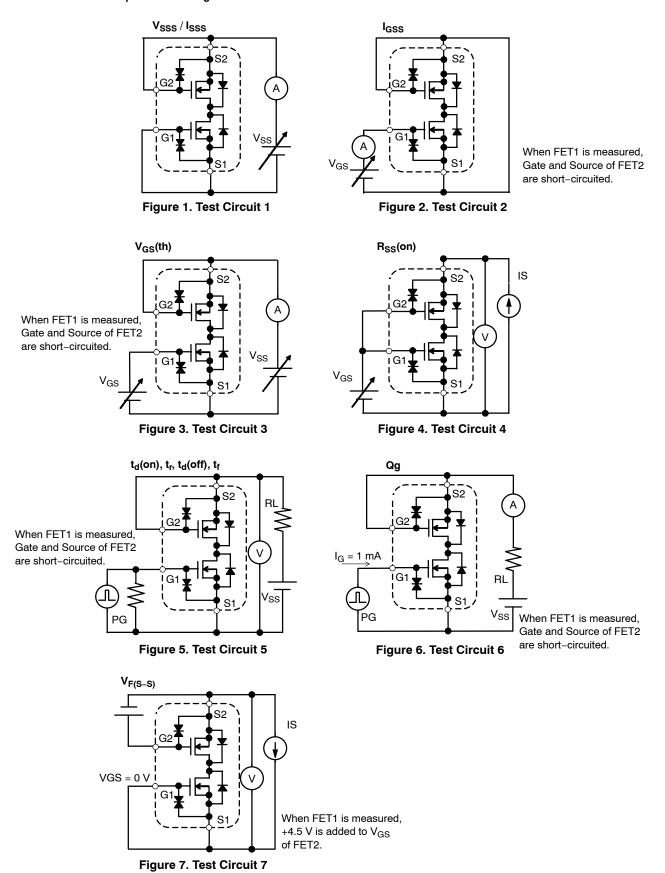
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

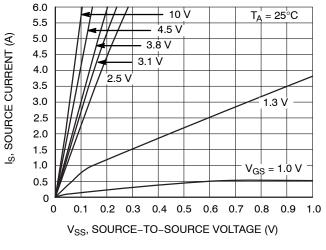
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Source to Source Breakdown Voltage	V _{(BR)SSS}	$I_S = 1 \text{ mA}, V_{GS} = 0 \text{ V}$ (Figure 1)	20	-	-	V
Zero-Gate Voltage Source Current	I _{SSS}	V _{SS} = 20 V, V _{GS} = 0 V (Figure 1)	-	-	1	μΑ
Gate to Source Leakage Current	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{SS} = 0 \text{ V} \text{ (Figure 2)}$	-	-	±1	μΑ
Gate Threshold Voltage	V _{GS} (th)	V _{SS} = 10 V, I _S = 1 mA (Figure 3)	0.5	-	1.3	V
Static Source to Source On-State	R _{SS} (on)1	I _S = 2 A, V _{GS} = 4.5 V (Figure 4)	17	23	30	mΩ
Resistance	R _{SS} (on)2	I _S = 2 A, V _{GS} = 3.8 V (Figure 4)	19.5	26	34	mΩ
	R _{SS} (on)3	I _S = 2 A, V _{GS} = 3.1 V (Figure 4)	21	28	39	mΩ
	R _{SS} (on)4	I _S = 2 A, V _{GS} = 2.5 V (Figure 4)	24.5	35	56	mΩ
Turn-ON Delay Time	t _d (on)	V _{SS} = 10 V, V _{GS} = 4.5 V, I _S = 2 A	-	50	-	ns
Rise Time	t _r	(Figure 5)	-	350	-	ns
Turn-OFF Delay Time	t _d (off)		-	42000	-	ns
Fall Time	t _f		-	47000	-	ns
Total Gate Charge Qg		V _{SS} = 10 V, V _{GS} = 4.5 V, I _S = 6 A (Figure 6)	-	15	-	nC
Forward Source to Source Voltage	V _{F(S-S)}	I _S = 2 A, V _{GS} = 0 V (Figure 7)	-	0.81	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test Circuits are Example of Measuring FET1 Side



NOTE: When FET2 is measured, the position of FET1 and FET2 is switched.



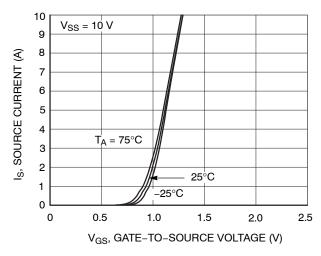
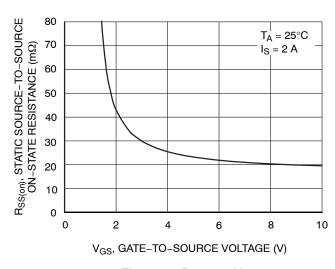


Figure 8. I_S - V_{SS}

Figure 9. I_S - V_{GS}



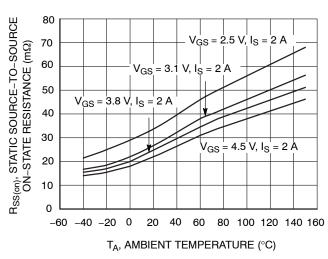
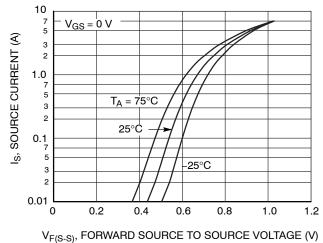


Figure 10. R_{SS(on)} - V_{GS}

Figure 11. R_{SS(on)} – Ta



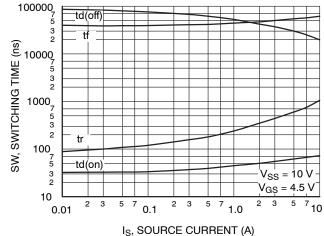


Figure 12. I_S - V_{F(S-S)}

Figure 13. SW Time - I_S

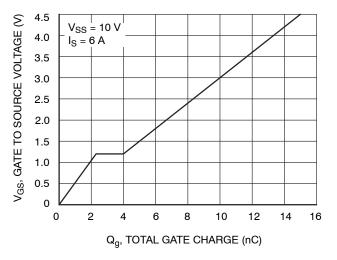


Figure 14. V_{GS} - Qg

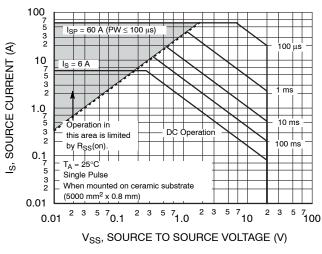


Figure 15. SOA

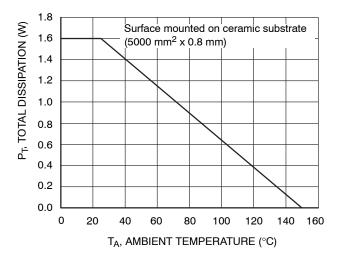


Figure 16. P_T – Ta

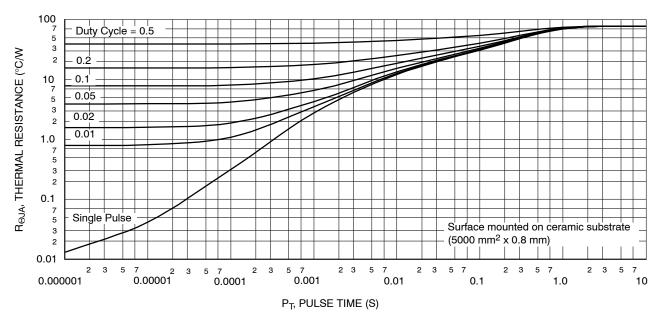


Figure 17. $R_{\theta JA}$ – Pulse Time

ORDERING INFORMATION

Device	Marking	Package	Shipping [†] (Qty / Packing)
EFC3C001NUZTCG	WC	WLCSP4, 1.26 x 1.26 / EFCP1313-4DG-020 (Pb-Free / Halogen Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

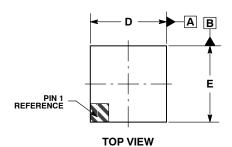
Note on usage: Since the EFC3C001NUZ is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

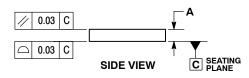


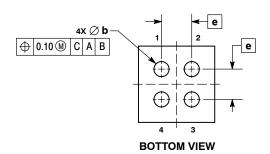


WLCSP4 1.26x1.26 / EFCP1313-4DG-020 CASE 567LM ISSUE O

DATE 10 APR 2015



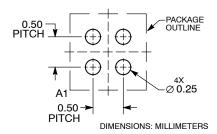




- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.18	0.22	
b	0.22	0.28	
D	1.21	1.31	
Е	1.21	1.31	
е	0.50 BSC		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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